

Activities in Padova on ITS3 prototypes

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ITS3 ER1/ER2 Characterisation@INFN

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Outline



- babyMOSS
 - Test beam at CERN PS
 - Laboratory characterization
- APTS-SF: laboratory characterization of irradiated chips
- Facilities in Padova
- Interests/possible tests for ER2

babyMOSS

Test beam activity at CERN PS (September 2024)

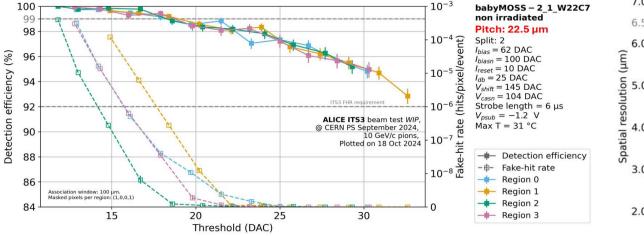
- MOSS-RAISER telescope constituted of 6 babyMOSS tracking planes
- Tested 3 babyMOSS DUTs: 1 non irradiated, 2 irradiated to 10¹³ 1 MeV n_{eq} /cm²

Measurements for efficiency and spatial resolution studies:

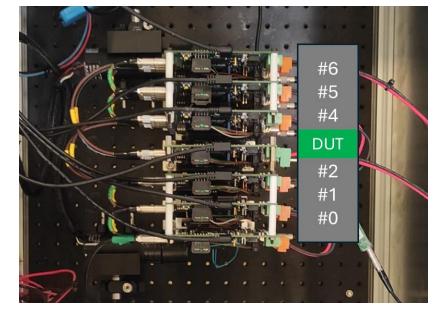
- Threshold scan
- Common threshold scan (only for non irradiated DUT)

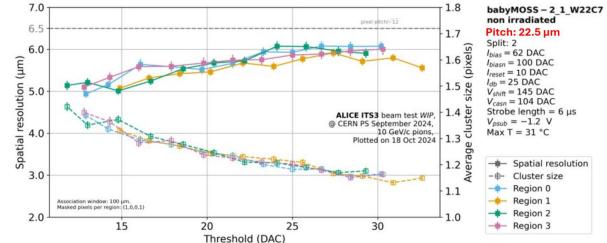
Data analysis carried out using Corryvreckan software

Results for top HU of non irradiated DUT





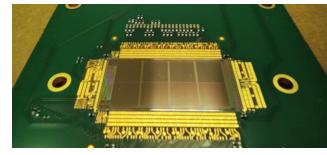




babyMOSS Lab characterization

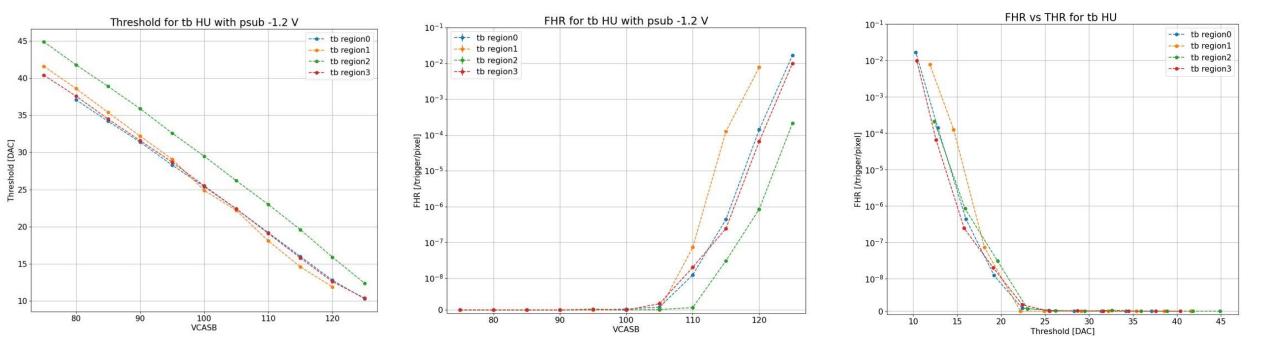


1 babyMOSS chip in Padova: babyMOSS-1_1_W06D0



- Functional tests
 bb region 0 not working for SA fault
 of column 94 in digital scan
- Threshold scan
- 🗸 Fake Hit Rate scan

Mask settings for analysis: tb region 0: column 109 masked tb region 1: masked pixel (19,175) bb region 3: masked (141,108), (191, 124) and (141, 206)

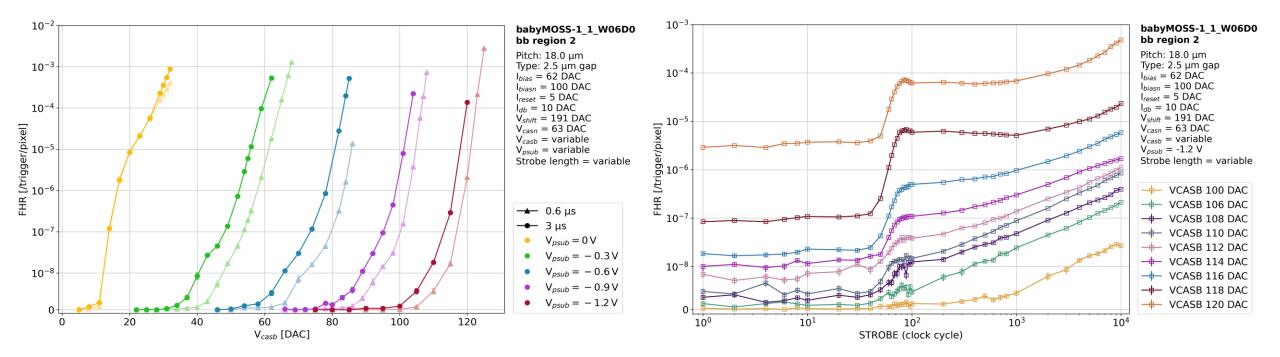


babyMOSS

Lab characterization

More detailed studies on Fake Hit Rate

Studies of FHR as a function of psub voltage and strobe length



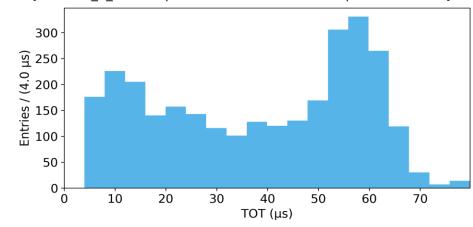


babyMOSS

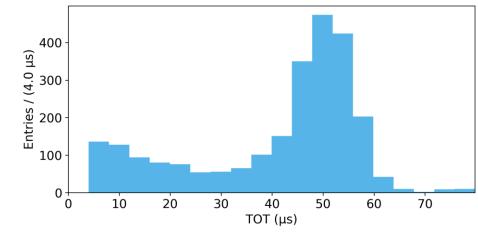
Lab characterization

TOT scan with ⁵⁵Fe (with source_tot_scan.py)

region 1 babyMOSS-1 1 W06D0 | TOT distribution for tb HU | SourceTotAnalysis



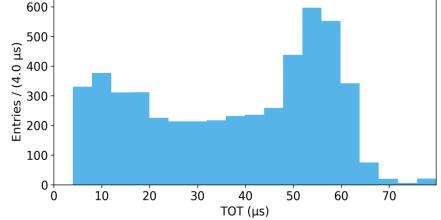
babyMOSS-1_1_W06D0 | TOT distribution for bb HU | SourceTotAnalysis



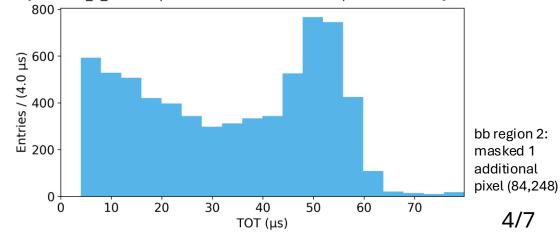


psub = -1.2 V, default DAC values, IRESET = 5, n_events = 1 M

region 2 babyMOSS-1_1_W06D0 | TOT distribution for tb HU | SourceTotAnalysis



babyMOSS-1_1_W06D0 | TOT distribution for bb HU | SourceTotAnalysis



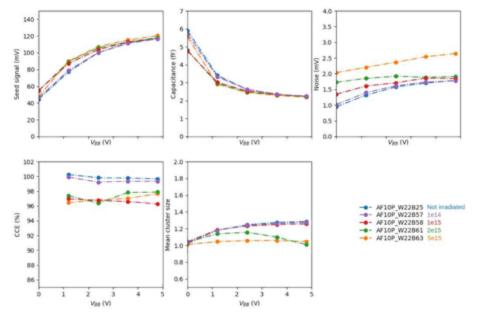
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APTS-SF

Lab characterization of irradiated chips

Tests of **irradiated** APTS-SF, repeated for different reverse bias voltages (DAQ+proximity+carrier inside cold box):

- Test pulse: check if all pixels are working;
- Threshold scan: set hardware threshold;
- Gain: check baseline and working point conditions;
- Source measurement: data acquisition with radioactive sources ⁵⁵Fe, ⁹⁰Sr;
- Leakage current tests: tests to measure leakage current.

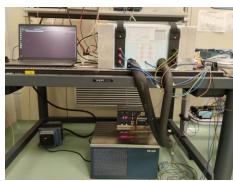


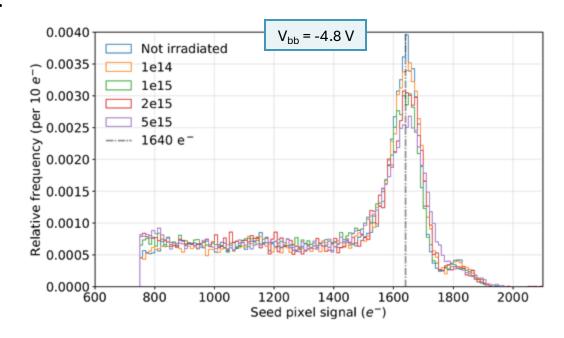


Cold box

DAQ+proximity+carrier







Facilities in Padova

- **Radioactive sources**: ⁵⁵Fe, ⁹⁰Sr
- NIR pulsed laser
- Xray tube (W) with setup for X-ray fluorescence already used for sensor characterization Available target materials:

Element

Al

Ti

Fe

Cu

Energy Ka₁ [keV]

1.486

4.510

6.404

8.048

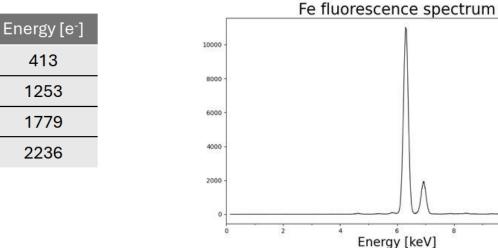
413

1253

1779

2236

- **Coldbox:** RTE-4DD Refrigerated Bath Circulator Temperature range from – 30 °C to 100 °C Drier for dry air flow
 - Temperature and humidity probes for monitoring





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Interest/possible tests for ER2



- Exploration of parameter space
- Study of the pixel **response linearity**
- Test of **irradiated** samples (ITS3, ALICE3)
 - This was done in Padova for MLR1 APTS chips up to a fluence of 2 × 10¹⁵ 1 MeV n_{eq} /cm² (not clear how to receive chips irradiated to higher doses)